

### **FEATURES**

- Average Forward Current:I<sub>F(AV)</sub>=1A
- Polarity: Color band denotes cathode



## **Package Marking and Ordering Information**

Product ID	Pack	Marking	Qty(PCS)				
ES1AF-ES1JF	SMAF	ES1 <b>★</b> F	10000				



★:From A-M

## MAXIMUM RATINGS (Ta=25 unless otherwise noted)

Item	Symbol	Unit	Test Conditions	ES1								
			rest Conditions	AF	BF	CF	DF	EF	GF	HF	JF	
Repetitive Peak Reverse Voltage	$V_{RRM}$	V		50	100	150	200	300	400	500	600	
Maximum RMS Voltage	V <sub>RMS</sub>	V		35	70	105	140	210	280	350	420	
Average Forward Current	I <sub>F(AV)</sub>	А	60Hz Half-sine wave , Resistance load , T <sub>L</sub> =120 ℃	1.0								
Surge(Non-repetitive)Forward Current	I <sub>FSM</sub>	Α	60Hz Half-sine wave, 1 cycle,Ta=25℃	30								
Operation Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	$^{\circ}$		-55 ~ +150								

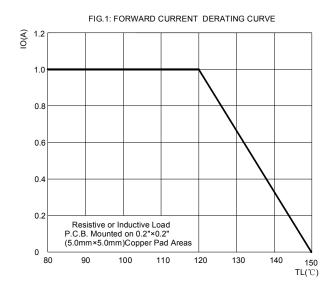
# ELECTRICAL CHARACTERISTICS (Ta=25 unless otherwise specified)

14	0	Unit	Test Condition			ES1							
Item	Symbol		rest Condition		AF	BF	CF	DF	EF	GF	HF	JF	
Peak Forward Voltage	$V_{F}$	V	I <sub>F</sub> =1.0A			0.95			1.25		1.70		
Maximum reverse recovery time	t <sub>rr</sub>	ns	I <sub>F</sub> =0.5A,I <sub>R</sub> =1.0A,I <sub>π</sub> =0.25A			35							
Peak Reverse Current	I <sub>RRM1</sub>		μA V <sub>RM</sub> =V <sub>RRM</sub>	Ta =25℃	5								
	I <sub>RRM2</sub>	μΑ		Ta=100℃	100								
Thermal	$R_{\theta J-A}$		Between junction	n and ambient	85								
Resistance(Typical)	$R_{\theta J-L}$	°C/W	Between junction	n and terminal	35								

#### Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

### **Typical Characteristics**



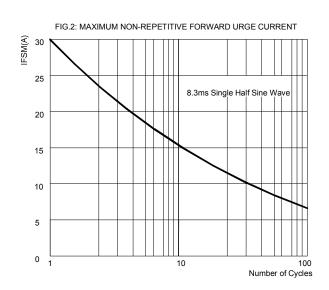


FIG.3: TYPICAL FORWARD CHARACTERISTICS

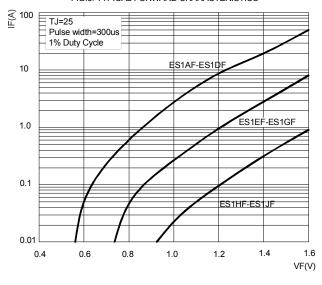


FIG.4: TYPICAL REVERSE CHARACTERISTICS

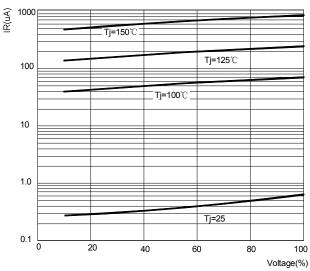
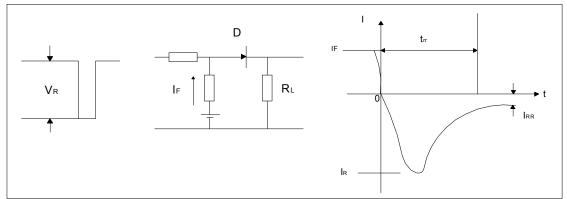
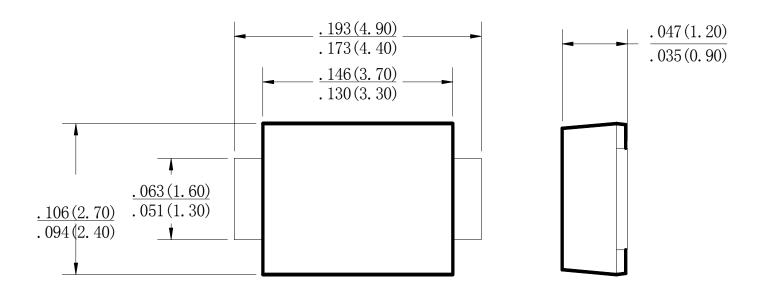
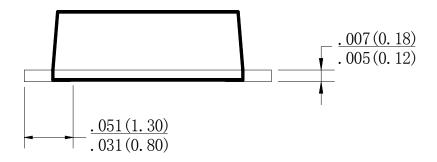


FIG.5: Diagram of circuit and Testing wave form of reverse recovery time



# **SMAF Package Outline Dimensions**





Dimensions in inches and (millimeters)



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